This Page Is Inserted by IFW Operations and is not a part of the Official Record

BEST AVAILABLE IMAGES

Defective images within this document are accurate representations of the original documents submitted by the applicant.

Defects in the images may include (but are not limited to):

- BLACK BORDERS
- TEXT CUT OFF AT TOP, BOTTOM OR SIDES
- FADED TEXT
- ILLEGIBLE TEXT
- SKEWED/SLANTED IMAGES
- COLORED PHOTOS
- BLACK OR VERY BLACK AND WHITE DARK PHOTOS
- GRAY SCALE DOCUMENTS

IMAGES ARE BEST AVAILABLE COPY.

As rescanning documents will not correct images, please do not report the images to the Image Problems Mailbox.

THIS PAGE BLANK (USPTO)



WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau



INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT) 0 99/16941

INTERNATIONAL APPLICATION FUBLISH	(11) International Publication Number:	WO 99/16941
(51) International Patent Classification ⁶ : C30B 29/22, C22F 1/00, B05D 15/04,	 • •	8 April 1999 (08.04.99)
31/26		DAY DII European natent

PCT/US98/20407 (21) International Application Number:

(22) International Filing Date: 30 September 1998 (30.09.98)

(30) Priority Data: 1 October 1997 (01.10.97) US 08/942,038

(71) Applicants: AMERICAN SUPERCONDUCTOR CORPORA-TION [US/US]; Two Technology Way, Westborough, MA 01581 (US). THE REGENTS OF THE UNIVERSITY OF CALIFORNIA [US/US]; 21st floor, 300 Lakeside Drive, Oakland, CA 94612-3550 (US).

(72) Inventors: FRITZEMEIER, Leslie, G.; 72 Concord Road, Acton, MA 01720 (US). THOMPSON, Elliott, D.; 157 Rathbun Street, Coventry, RI 02816 (US). SIEGAL, Edward, J.; 28 Magnolia Street, Malden, MA 02148 (US). THIEME, Cornelis, Leo, Hans; 21 Mill Road, Westborough, MA 01581 (US). CAMERON, Robert, D.; 90 Daniels Street, Franklin, MA 02038 (US). SMITH, James, L.; 320 Donna Avenue, Los Alamos, NM 87544 (US). HULTS, W., Larry; 811 Tiffany Court, Los Alamos, NM 87544 (US).

(74) Agent: WALPERT, Gary, A.; Fish & Richardson P.C., 225 Franklin Street, Boston, MA 02110-2804 (US).

(81) Designated States: AU, CA, CN, JP, NZ, RU, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

Published

With international search report. Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.

(54) Title: SUBSTRATES FOR SUPERCONDUCTORS

- 11
ᅰ.
- 1
\dashv

(57) Abstract

An alloy capable of forming a (100) [001] cube-texture by thermo-mechanical techniques has 5-45 atomic percent nickel with the balance being copper. The alloy is useful as a conductive substrate for superconducting composites where the substrate is coated with superconducting oxide. A buffer layer can optionally be coated on the substrate to enhance deposition of the superconducting oxide. T method for producing the alloy includes weighing the metal (101), melting and cooling the constituents (102). The alloy is remelted (10) and shaped (104). The alloy is then mechanically deformed to a smaller size and recrystallize (105) then deformed in an axially mani (106) and planar deformation (107). The final step is heat treated (108).

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL	Albania	ES	Spain	LS	Lesotho	Si	Slovenia
AM	Armenia	FI	Finland	LT	Lithuania	SK	Slovakia
AT	Austria	FR	France	LU	Luxembourg	SN	Senegal Senegal
AU	Australia	- GA	Gabon	LV	Larvia	SZ	Swaziland
AZ	Azerbaijan	GB	United Kingdom	MC	Monaco	TD	Chad
BA	Bosnia and Herzegovina	GE	Georgia	MD	Republic of Moldova	TG	Togo
BB	Barbados	GH	Ghana	MG	Madagascar	ŢĴ	
BE	Belgium	GN	Guinea	MK	The former Yugoslav	TM	Tajikistan
BF	Burkina Faso	GR	Greece		Republic of Macedonia	TR	Turkmenistan
BG	Bulgaria	HU	Hungary	ML	Mali	TT	Turkey
BJ	Benin	IE	Ireland	MN	Mongolia		Trinidad and Tobago
BR	Brazil	IL	Israel	MR	Mauritania	UA	Ukraine
BY	Belarus	IS	Iceland	MW	Malawi	UG	Uganda
CA	Canada	IT	Italy	MX	Maiawi Mexico	US	United States of America
CF '	Central African Republic	JP	Japan	NE		UZ	Uzbekistan
CG	Congo	KE	Келуа	NL NL	Niger	VN	Vict Nam
СН	Switzerland .	KG	Kyrgyzstan	NL NO	Netherlands	YU	Yugoslavia
CI	Côte d'Ivoire	KP	Democratic People's	-	Norway	zw	Zimbabwe
СМ	Cameroon		Republic of Korea	NZ	New Zealand		
CN	China	KR	Republic of Korea	PL	Poland		
CU	Cuba	KZ	Kazaksian	PT	Portugal		
CZ	Czech Republic	LC	Saint Lucia	RO	Romania		
DE	Germany	ш	Liechtenstein	RU	Russian Federation		
DK	Denmark	LK	Sri Lanka	SD	Sudan		
EE	Estonia	LR	Liberia	SE	Sweden •		
	Catonia	Ln	Liberia	SG	Singapore		

SUBSTRATES FOR SUPERCONDUCTORS

This invention was made under a Cooperative Research and Development Agreement with Los Alamos National Research Laboratory. The United States Government has certain rights in this invention.

Background of the Invention

The present invention relates to substrates for superconductors, and more particularly to copper-nickel substrates for receiving the deposition of YBCO (YBa₂Cu₃O_x, or Yttrium-Barium-Copper-Oxide) high temperature superconducting layers to form so-called YBCO coated conductors. Other closely related superconducting materials which can be used are REBa₂Cu₃O_x, in which the Y has been partially or completely replaced by rare earth (RE) elements.

YBCO $(Y-Ba_2-Cu_3-O_x)$ is an important superconducting material for the development of superconducting tapes that can be used in superconducting transmission cables,

- superconducting current leads, superconducting coils for transformers, superconducting magnets for AC and DC motor applications, and superconducting current limiters, as well as other electrical conductors. These applications are based on a basic property of a superconducting
- 25 material: it has no electrical resistance when cooled below its transition temperature, and can carry a DC electric current without power dissipation.

For the production of YBCO coated conductors, thin substrate tapes (or foils) are typically coated with a thin buffer layer, which in turn is coated with a YBCO layer. A suitable heat treatment is then performed to optimize the superconducting properties of the YBCO layer. One of the functions of the substrate is to impart mechanical strength to the resulting superconducting tape. A second function, which depends on the process type, is to act as a template for a well-textured buffer layer. Compared to the substrate material, this buffer layer provides a much better deposition surface for the YBCO layer in terms of lattice match, texture, coefficient of thermal expansion (CTE) and chemical compatibility. To obtain good

- superconducting properties, the buffer layer needs to be bi-axially textured meaning that a lattice plane, preferably its cubic (or tetragonal) lattice face, is oriented such that the cube face is parallel to the tape surface in a substantial majority of its crystallites.
- 20 In addition, the cube edge in each crystallite should be parallel to the cube edges in all neighboring crystallites.

Some specialized techniques such as Ion Beam Assisted Deposition (IBAD) or Inclined Substrate

25 Deposition (ISD) can deposit a bi-axially textured buffer layer on top of a random polycrystalline or even amorphous substrate. In general, these deposition narrow region, and they are not suited for large scale
and economical manufacturing of YBCO coated conductors.

A more advantageous method is the epitaxial deposition of
a bi-axially textured buffer layer (or YBCO
superconducting layer) on top of a bi-axially textured
metallic substrate. Examples of epitaxial growth by
vapor deposition, electro-plating, or oxidation, in which
native oxide layers grow on parent metals, are numerous
and well known, as is the fact that many metals can form
bi-axial textures. Few of these textures are useful for
deposition of buffer layers and YBCO superconducting
layers because of misorientation. However, in many
rolled, face-centered cubic (fcc) metals, when properly

15 rolled and heat treated, a well-developed, and very useful, cube texture is obtained. The cube faces are parallel to the rolled surface and a cube edge typically points in the same direction as the rolling direction.

Such a texture is called a cube-on-cube texture, with a

20 crystallographic notation of (100)[001]. Another well-known cube texture is the so-called Goss texture (100)[011]. These bi-axial textures are part of a larger family called sheet textures. In the following description of the invention the (100)[001] texture will be referred to as the "cube" texture.

To deposit the buffer layer in an epitaxial manner on the substrate, the substrate material needs to meet

certain requirements. The substrate must have a lattice constant and a CTE which are compatible with the buffer layer material and also with the YBCO layer. Ideally, the substrate will yield a bi-axial texture by simple thermo-mechanical means. The substrate is preferably non-magnetic at cryogenic temperatures, that is, at temperatures between room temperature and that of liquid helium, or 4.2 degrees Kelvin. The substrate must be electrically conductive, relatively strong at room temperature, and oxidation resistant at elevated

- temperature, and oxidation resistant at elevated temperatures. There are several metals, such as copper or nickel, that can be bi-axially textured by rolling a selected copper or nickel stock, followed by a so-called secondary recrystallization at an elevated temperature.
- 15 However, these pure metals have significant drawbacks in that they are either ferromagnetic (Ni) or are easy to oxidize (Cu).

It is known that some binary alloys (a single phase mixture of two metals) can be made into a bi-

- 20 axially textured tape as well. One example of a cube texture which has been produced in an alloy is iron-nickel, but this alloy has proven to be ferromagnetic, which is detrimental to the performance of the device in many applications. In addition, copper-nickel alloys 25 with small quantities of nickel have previously been
- textured, but those working in the field believed that

- 5 -

the maximum Ni content in the Cu-Ni alloy should not exceed 4.2 percent nickel.

Summary of the Invention

The present invention features bi-axially textured 5 alloys with a face centered cubic structure, of coppernickel (Cu-Ni) with 5 to 45 atomic % nickel, preferably 10-40% and more preferably 25-35%, for use as substrate materials for superconducting oxides. Preferred superconducting oxides include the Rare Earth Barium 10 Copper Oxides, (RE)BCO, or Yttrium Barium Copper Oxides, YBCO, but also superconducting oxides from the Thallium, Mercury and Bismuth families. The combination of the substrate and the oxide forms a coated conductor. Cu-Ni alloys are preferably homogenous, but can have some 15 degree of inhomogeneity with localized concentrations of Ni not exceeding 45%, and can be processed by thermomechanical methods to form tapes with a single (100) [001] cube texture. These alloys are non-ferromagnetic and form good substrate materials for subsequent epitaxial 20 buffer layer and superconductor layer deposition, for use in a variety of products.

The enhanced Ni content achieves desirable

features in the alloy, such as increased oxidation

resistance, decreased CTE, and increased room temperature

and high temperature strength. The increased Ni content

does not cause ferromagnetism as long as the Ni content

does not exceed 42% for applications down to 4.2 degrees

Kelvin or 45% for applications at temperatures between 4.2 and 77 degrees Kelvin. With the appropriate buffer layer material, this substrate will not adversely affect the superconducting properties of the superconducting 5 layer.

Cube-textured alloys of the present invention are formed by creating a homogenous solid solution of the alloying elements. The Cu and Ni constituents are weighed, mixed, and melted together to form a CuNi alloy.

- The starting materials are preferably at least 99% pure.

 The melt is then cooled to room temperature. The rate of cooling can be slow or fast, with a rapid quench preferred for giving a fine grain size. The solidified alloy is further homogenized by a heat treatment. The
- alloy is then processed into tape by mechanical means, such as rolling, after which a suitable heat treatment produces the desired cube texture. An optional recrystallization step after the homogenization and partial deformation of the alloy induces a refined grain
- 20 size of 5 to 70 micrometers, which obtains a cube texture in the rolled and heat treated tapes.

Brief Description of the Drawings

Fig. 1 is a block diagram illustrating the process of forming a cube-textured alloy substrate.

25 Fig. 2 illustrates a partial cross-sectional view of a superconductor composite formed with a cube-textured alloy substrate.

PCT/US98/20407 WO 99/16941

- 7 -

Fig. 3 illustrates a partial cross-sectional view of a superconductor composite formed with a cube-textured alloy substrate and a textured buffer layer.

Figs. 3A and 3B illustrate partial cross-sectional views of superconductor composites formed with multiple buffer layers.

Fig. 4 illustrates a partial cross-sectional view of a superconductor composite having both sides coated with a buffer layer and a superconducting layer.

10 Fig. 5 illustrates a cross-sectional view of a superconductor composite in which the coated layers surround the substrate.

Fig. 6 illustrates a cross-sectional view of a superconductor composite with multiple buffer and superconducting layers.

Figs. 7-10 are pole figures of cube-textured alloys.

Description of the Embodiments

The present invention provides an alloy with a

20 cube texture which is formed from a single phase mixture
of 5 to 45 atomic percent nickel with the balance being
copper. A method for making the alloy is also featured.

The cube texture is often indicated by the crystallographic notation (100) [001] and is typically formed by sheet or tape rolling of a suitable metal or alloy, followed by an appropriate heat treatment. Metals or alloys with a face centered cubic (fcc) structure, and

which have been processed to display a bi-axial cube texture, have crystallites in which the cube faces are parallel to a tape surface while the cube edges point in the rolling direction. The cube-textured alloys of the present invention are particularly useful as substrate materials for superconducting composites. The resulting tape-like structure includes a cube-textured substrate, on which, for example, a bi-axially textured buffer layer can be deposited using an epitaxial deposition process.

10 Subsequently, a bi-axially textured superconducting layer can be deposited, again using an epitaxial deposition process.

The quality of the bi-axial cube texture

determines the effectiveness of the substrate for use in

super-conducting composites. The orientation of the cube

oriented grains should be within a few degrees of the

ideal bi-axial cubic orientation. Grains with an

orientation which deviates from the cube texture, should

be small in number, preferably well below 15 vol%. The

- quality of these textures is revealed in their X-ray diffraction pole figures, which show the collective orientations of all crystallites in the irradiated area. Random orientations show no concentration in any direction. Quality textures, on the other hand, show
- sharp peaks in the pole figures. The sharpness of these peaks is expressed as the Full Width Half Maximum (FWHM) value and is indicative of texture quality. The lower

the FWHM value, the sharper the peak, and hence, the
better the texture. For polycrystalline materials, a FWHM
value of well below 10° is desired. Typically, FWHM
values on the order of 4-15° are achieved in the
substrates of this invention. Higher FWHM values can be
acceptable for substrate purposes, in particular if this
reduced texture is off-set by advantages in other areas,
such as improved oxidation resistance, or better chemical
or CTE compatibility. In general, alloy substrates result
in FWHM values that are often slightly higher than the
FWHM values of similarly treated pure metal constituents.
The alloying does, however, lead to advantages as
mentioned above, such as a non-magnetic substrate,
improved oxidation resistance, and improved CTE.

When these substrates are used to form superconducting composites, a buffer layer and superconducting
layer can be on one side, both sides, partially, or
entirely surround the substrate conductor. The buffer
layer can be a metal layer or oxide layer, or

- combinations of both. Each must provide the needed texture, chemical compatibility, matching lattice constant, and proper CTE match. For example, the buffer layer can be a noble metal or noble metal alloy, an oxide with a cubic structure such as, but not limited to, MgO,
- 25 CeO₂, Yb₂O₃, or yttria-stabilized zirconia ("YSZ"), or any combination of oxides and/or noble metals. The buffer layer, which can include multiple layers, is preferably

deposited in an epitaxial manner, in which the bi-axial texture of the substrate is transferred onto the buffer layer, or first layer of the buffer layer if multiple buffer layers are employed. In this latter instance, each buffer layer transfers its texture to the next layer until the buffer layer is completed. Finally, the top buffer layer transfers its texture onto the YBCO superconducting layer.

Cube-textured alloys of the present invention are

formed by creating a homogenous solid solution of the
alloying elements. The Cu and Ni constituents are
weighed, mixed, and melted together to form a CuNi alloy.
The starting materials are preferably at least 99% pure.
The melt is then cooled to room temperature. The rate of

- 15 cooling can be slow or fast, with a rapid quench preferred for giving a fine grain size. The solidified alloy is further homogenized by a heat treatment. The alloy is then processed into tape by mechanical means, such as rolling, after which a suitable heat treatment
- produces the desired cube texture. An optional recrystallization step after the homogenization and partial deformation of the alloy induces a refined grain size of 5 to 70 micrometers, which obtains a cube texture in the rolled and heat treated tapes.
- The binary alloys of the present invention have 5 to 45 atomic percent nickel, preferably 25 to 35%, with the balance being copper. The upper limit of 45 atomic

percent nickel is established to minimize the risk of developing ferromagnetic properties, which are detrimental to the performance of the device in many applications of the oxide layer. Further, by remaining below the upper limit, the strong bi-axial cube texture of the alloy is maintained, and the alignment of lattice edges allows the alloy to act as a substrate for superconducting applications.

Referring to Fig. 1, a block diagram illustrates 10 the process 100 for forming a cube-textured alloy. cube-textured binary alloys of the present invention are created by first selecting and weighing the constituent metals (Step 101) in a mixture of 5 to 45 atomic percent nickel, preferably 10-40% and more preferably 25 to 35%, 15 with the balance being copper. This solid solution is then melted (Step 102) by various processes known in the art, such as arc melting, induction melting, plasma torch melting, or melting in an electrical resistance furnace or a furnace heated by gas or coal. Melting temperatures 20 range from 1100°C to 1250°C. A certain level of homogenization is achieved during the melt process due to convection, mechanical stirring, or stirring induced by the melting techniques such as the induction melter. The melting can be performed in air, under vacuum, or under a

melting can be performed in all, under vacuum, of ander of protective inert atmosphere such as nitrogen, argon or helium etc. The melting can be repeated several times to further increase homogenization (Step 103). The melt is

then cooled with the furnace. The solidified melt is shaped, preferably, into a bar. The bar is reduced in diameter by rod rolling, swaging, drawing or extrusion by a factor of about 1.3 to about 20, preferably about 1.3

- 5 to 5, and heat treated to further homogenize the alloy (Step 104). A further mechanical reduction in diameter by similar mechanical means follows, to a size where the planar deformation process will commence (Step 105).

 Before or at this stage a heat treatment can be applied
- to recrystallize the alloy and obtain a fine grain size of approximately 5 to 70 micrometers, preferably greater than 10 micrometers and less than 40 micrometers (also Step 105). Alternatively, other methods can be utilized to achieve a fine grain size, such as the rapid
- solidification of the alloy after melting. An example is the atomization of a melt into an alloy powder, which is subsequently consolidated by (hot) pressing or extrusion into a bar, and which is processed subsequently similar to a cast alloy. The alloy sample is subsequently
- deformed in an axially symmetric manner, such as extrusion, swaging, drawing, or rod rolling to a smaller size which can be round, square or rectangular (Step 106). In yet another alternate process step, the melt can be cast and rolled. This cast can be further homogenized with a suitable heat treatment, rolled to a thinner size,

and recrystallized to induce a fine grain size.

The alloy is then deformed further by various

planar rolling methods known in the art (Step 107), to

reduce the thickness of the stock by at least 85% and up

to 99.9%. The planar deformation is performed at

5 temperatures between -200 and 600°C, and preferably at

room temperature. A recrystallization anneal (Step 108)

at a temperature exceeding 250°C, but not more than 95% of

the melting temperature, and preferably at temperatures

between 400 and 1190°C, produces the desired single cube

10 texture (100) [001]. Fig. 7 shows a (111) pole figure, of

a Cu-16 at% Ni alloy, which demonstrates a single and

high quality (100) [001] cube texture. This alloy is made

by extrusion of the homogenized alloy to tape, rolling

the tape to a reduction in thickness of 96%, and heat

15 treating the final tape at 850°C for 4 hours in a protective atmosphere. (See Example 3).

Rolling processes suitable for use with the

present invention utilize the following parameters.

Rolling is typically performed at room temperature, with

20 rolling between 0.10m/minute and 100m/minute. The

reduction schedule can be a constant reduction per pass,

or a constant strain per pass, with reduction steps

chosen to be between 5 and 40% per pass. The tape can

be lubricated during rolling, or rolled without any

25 lubricant. Bidirectional rolling is preferred. The

tapes can be rolled with large diameter rolls (3.5" to 8"

or larger in diameter) or preferably with small diameter

rolls (0.75" to 2" in diameter) which can be backed up by larger rolls, in a so-called four-high arrangement.

Alternatives to the four-high arrangement are cluster and planetary rolling mills.

- Referring to Fig. 2, a partial cross section of a superconducting composite 200 is shown. To form a superconducting composite 200, the above described substrates 201 of cube-textured alloys have at least one surface 202 coated with a superconducting oxide 203, such as yttrium-barium-copper-oxide (YBCO) or a rare earth barium copper oxide (REBCO) or mixtures of these. The REBCO's are formed by partial or complete substitution of yttrium (Y) in the YBCO with rare earth elements such as praesodium, neodymium, samarium, europium, gadolinium,
- 15 terbium, dysprosium, holmium, erbium, thulium, ytterbium, lutetium, lanthenum, or cerium. The coating of the superconducting oxide 203 is preferably approximately 0.2 to 20 micrometers thick, more preferably 1-20 micrometers thick. The coating is applied by any deposition
- 20 technique, such as a non-vacuum solution deposition, electroplating, chemical vapor deposition, or physical vapor deposition techniques, such as sputtering, laser ablation, thermal evaporation, electron beam evaporation. These deposition techniques can require a heat treatment,
 25 such as that disclosed in U.S. Patent No. 5,231,074

issued to Cima et al., fully incorporated herein by

reference, to form the YBCO in an epitaxial manner, and optimize its superconducting properties.

In the Cima patent, highly-textured superconductor oxide thin films are prepared on substrates, including 5 lattice matched, non-lattice matched, inert and non-inert materials, by metal organic deposition (MOD). Precursor solution composition, as well as processing temperature and atmosphere are selected to control the presence of a transient liquid phase. Superconductor oxide films 10 characterized by highly textured morphologies and fully dense, homogeneous microstructures are capable of sustaining critical current densities in excess of 104 A/cm² at 77 degrees K. when prepared on non-lattice matched substrates or critical current densities in 15 excess of 10° A/cm² at 77 degrees K. when prepared on

lattice-matched substrates.

Referring now to Fig. 3, in order to improve the surface characteristics of the substrate 301 of composite 300, for receiving a superconducting oxide coating 303, a 20 buffer layer (or multiple buffer layers) 302 is deposited in an epitaxial process onto the cube-textured alloy substrate 301. Any of the deposition processes listed above, among others, can be used for depositing the buffer layer 302. A heat treatment can be included to 25 form the buffer layer in an epitaxial manner. The buffer layer 302 has a thickness of approximately 0.1 to 10.0 micrometers, and preferably 0.1 to 5.0 micrometers more

preferably 0.2 to 0.8 micrometers. It includes a single metal or oxide layer, or can be a multiple layered structure. A structure in which the buffer layer has two layers is shown in Fig. 3A where the substrate 301 is 5 covered with a layer 304 and subsequently a second layer 305, where the combination of layers 304 and 305 form the buffer layer. The multiple layers 304 and 305 can include any combination of layers, such as a metal layer 304 with an oxide layer 305 on top, or an oxide layer 304 10 with another oxide layer 305 on top. Alternatively, referring to Fig. 3B, the buffer layer can include three or even more layers. In this arrangement, the substrate 301 is coated with a metal or oxide layer 306 which in turn is coated with additional metal or oxide layers 307 15 and 308 before deposition of the superconducting layer 303.

Referring to Figs. 3, 3A and 3B, a top layer 310 comprising a noble metal (such as silver, gold, palladium, platinum, rhodium, iridium, rhenium or alloys thereof) is optionally deposited on the superconducting layer 303. This layer 310 prevents environmental degradation of the superconducting layer, and provides an alternative current path if the superconducting layer is locally degraded and unable to fully carry the

additional site to solder the conductor.

The metals for the top and buffer layers are typically noble metals or noble metal alloys. By "noble metal" is meant a metal whose reaction products are thermodynamically stable under the reaction conditions 5 employed relative to the desired superconducting ceramic, and/or a metal which does not react with the superconducting ceramic or its precursors under the conditions of manufacture of the composite. The noble metal can be a metal different from metallic matrix 10 elements of the desired superconducting ceramic. The noble metal can be silver or a silver/gold alloy, but it can also be a stoichiometric excess of one of the metallic elements of the desired superconducting ceramic, such as yttrium. Silver (Ag) and silver alloys are the 15 most preferred noble metals. Other noble metals include platinum, gold, palladium, rhodium, iridium, ruthenium, rhenium or alloys thereof. The oxides that are used for the buffer layers are typically stable oxides with a cubic structure such as MgO, cubic Al₂O₃, yttria, YSZ, or 20 rare earth oxides such as CeO_2 , Yb_2O_3 etc. or mixtures of

By coating the entire substrate, front, back, and/or the sides, with a buffer layer before the deposition of the superconducting layer, the oxidation resistance of the substrate is improved. Fig. 3 shows a substrate with this optional buffer layer 309 on the bottom side of the substrate.

Referring to Fig. 4, there is shown a partial cross-section of a superconducting composite 400. In this embodiment, the composite 400 has a substrate 401 with a pair of surfaces that are each coated with a buffer layer 402. A superconducting oxide 403 is coated on each of the buffer layers 402. In an alternate arrangement, as shown in Fig. 5, the composite 500 has a substrate 501 which is fully surrounded by a buffer layer 502. Furthermore, a superconducting oxide layer 503 fully coats the buffer layers 502 on all surfaces of the composite 500.

Referring to Fig. 6, there is shown a partial cross section of a superconducting composite 600. In this embodiment, the composite 600 has a substrate 601

- with a pair of surfaces that are each coated with a buffer layer 602. A superconducting oxide 606 is then coated on one side of buffer layer 602. A second buffer layer 603 is coated onto layer 606, after which a second superconducting oxide layer 607 is deposited on this
- buffer layer 603. In this manner, a multi-layered structure can be built which, for example, has four superconducting layers (606, 607, 608 and 609) interspersed with three substrate layers (603, 604, and 605). This multiple structure increases the current
- 25 carrying capability of the conductor. In this example, the top superconducting layer 609 is coated with a noble metal layer 610 for environmental protection of the

WO 99/16941 PCT/US98/20407

- 19 -

superconductor 609, an alternate current path, and additional sites to solder the conductor.

EXAMPLE 1

A cube-textured copper-nickel alloy according to 5 the present invention is produced according to the following method. 99.99% pure Ni and Cu pieces (pellets mixed with coarse powders) are weighed in a ratio of 68 at% Cu and 32 at% Ni. The pieces are mixed and loaded in a water cooled copper hearth of an arc melter which 10 operates in a protective atmosphere. The Cu+Ni mixture is melted and solidified several times, to ensure adequate mixing, at a temperature well above the melting temperatures for several minutes. The solidified and cooled alloy is mechanically formed in the shape of a 15 solid cylinder, and is rolled, using 10% deformation per pass, to a total reduction of 99% without any intermediate stress anneal process. The resulting tape is heat treated at 850°C for 4 hrs using a protective gas of 95% argon and 5% hydrogen. This tape shows mainly a 20 single, bi-axial cube texture, with a minor twinning element which can be seen in the (111) pole figure of Fig. 8.

EXAMPLE 2

A 32 mm diameter oxygen free copper can is loaded 25 with a mixture of Cu and Ni pieces, and the overall exact

stoichiometry (including the weight of the copper can) is further adjusted with Cu powder, to a mixture of 16 at% Ni, 84 at% Cu. This can is placed inside a 38 mm diameter thin-walled alumina crucible and heated in a

- 5 protective atmosphere using a induction melter at about 1170°C, for up to 5 minutes. The use of the induction melter and the fact that the alumina is not an electrical conductor causes stirring in the melt, which promotes homogenization. After solidification, the alloy is
- removed from the crucible. To enhance homogeneity, the cast is remelted using a similar crucible and the same induction melter, again under vacuum and at the same conditions. The cast alloy, which has a cylindrical shape, is machined to a diameter of 31 mm and extruded to
- 15 a 17 mm diameter bar. This bar is homogenized at 950°C for 24 hrs. It is machined to a 16 mm diameter billet, suitable for hydrostatic extrusion. It is extruded to a 3 mm diameter wire and subsequently rolled using a reversible direction rolling technique, with a four-high
- 20 rolling mill at a rolling speed of 6 m/min, and reduction per pass of 10%. The total reduction in thickness is 98.9%. Subsequently, it is heat treated at 850°C for 4 hrs under a 95% argon 5% hydrogen gas mixture. This tape has a single bi-axial cube texture and a FWHM value
- 25 of 6°. A (111) pole figure is shown of this alloy in Fig. 7. The pole figure demonstrates a single, high quality cube texture.

- 21 -

EXAMPLE 3

A similar process is followed as in Example 2, but the mixture is 26.5 at% Ni and 73.5 at % Cu. The alloy was extruded to a tape, which was rolled to a reduction in thickness of 96%. The tape was heat treated for 4 hours at 850 degrees Celsius. The final tape made with this alloy has a single bi-axial cube texture, with a FWHM value of 12°. A (111) pole figure of this alloy is shown in Fig. 9.

10

EXAMPLE 4

A similar process is followed as in Example 2, but now the mixture is 37 at% Ni and 63 at % Cu. The final foil made with this alloy again has a single bi-axial (100) [001] cube texture, with a FWHM value of 10°. A (111) pole figure of this alloy is shown in Fig. 10.

It will be obvious to those skilled in the art that various changes and modifications can be made therein without departing from the scope of the invention as defined by the appended claims.

What is claimed is:

- 1. A cube-textured alloy comprising 5 to 45 atomic percent nickel and the balance being copper.
- A superconducting composite comprising,
 a cube-textured alloy substrate formed from an alloy with 5 to 45 atomic percent nickel and the balance being copper, and
 - a superconducting oxide coating said cube-textured alloy substrate on at least one surface.
- 3. The superconducting composite of claim 2 wherein the superconducting oxide is a rare earth superconducting copper oxide.
- The superconducting composite of claim 2
 wherein the superconducting oxide is one of the yttrium barium-copper-oxide superconducting phases.
 - 5. The superconducting composite of claim 2 wherein said superconducting oxide coating has a thickness of approximately 1 micrometer to 20 micrometers.
- 6. A superconducting composite comprising, a cube-textured alloy substrate comprising an alloy of 5 to 45 atomic percent nickel with the balance being copper.
- a buffer layer coated on said substrate, and 25 a superconducting oxide coated on said buffer layer.
 - 7. The superconducting composite of claim 6 wherein the superconducting oxide is a rare earth

PCT/US98/20407

superconducting copper oxide, a yttrium-barium-copper superconducting oxide or mixtures thereof.

- The superconducting composite of claim 7
 wherein the superconducting oxide is one of the yttrium barium-copper-oxide superconducting phases.
 - 9. The superconducting composite of claim 6 wherein said superconducting oxide coating has a thickness of approximately 1 micrometer to 20 micrometers.
- 10. The superconducting composite of claim 6 wherein said buffer layer has a thickness of approximately 0.1 micrometer to 10 micrometers.
- 11. The superconducting composite of claim 6 wherein said buffer layer comprises metals, alloys, 15 oxides, or combinations thereof.
 - 12. A process for forming a cube-textured alloy comprising the steps of:

creating a mixture of 5 to 45 atomic percent nickel and the balance being copper;

20 melting said mixture into a single phase liquid;
solidifying a copper-nickel alloy from said single
phase liquid;

deforming said alloy; planar deforming said alloy; and

- heat treating said alloy to form a bi-axially textured alloy with a cube texture.
 - 13. The process of claim 12 further comprising the step of homogenizing said alloy with a heat treatment

after said deforming step and before said planar deforming step.

- 14. The process of claim 12 wherein said planar deforming step is performed at room temperature.
- 5 15. The process of claim 12 wherein said planar deforming step is performed between -200 and +600°C.
- 16. The process of claim 12 further comprising the step of deforming said alloy in an axially symmetric manner after said deforming step, and before said planar deforming step.
 - 17. A process for forming a superconducting composite comprising the steps of:

forming a cube-textured alloy substrate from an alloy of 5 to 45 atomic percent nickel and the balance

- 15 being copper, said substrate having at least one surface; coating said at least one surface of said substrate with a superconducting oxide.
- 18. The process of claim 17 wherein said superconducting oxide is a rare earth superconducting copper oxide, a yttrium-barium-copper superconducting oxide or mixtures thereof.
 - 19. The process of claim 18 wherein said superconducting oxide is one of the yttrium-barium-copper-oxide superconducting phases.
- 25 20. The process of claim 17 wherein said superconducting oxide coating has a thickness of approximately 1 micrometer to 20 micrometers.

21. A process for forming a superconducting composite comprising the steps of:

forming a cube-textured alloy substrate from an alloy of 5 to 45 atomic percent nickel and the balance 5 being copper;

depositing a buffer layer on said substrate; depositing a superconducting oxide on said buffer layer.

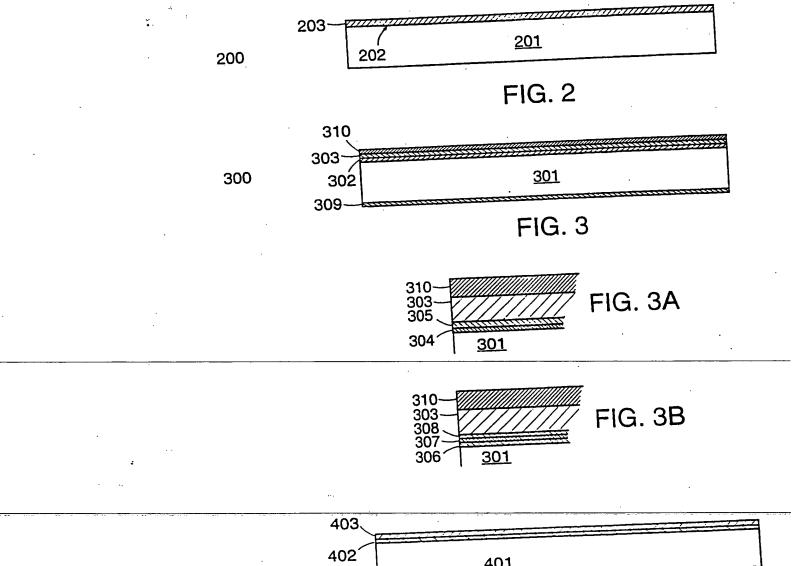
- 22. The process of claim 21 wherein said

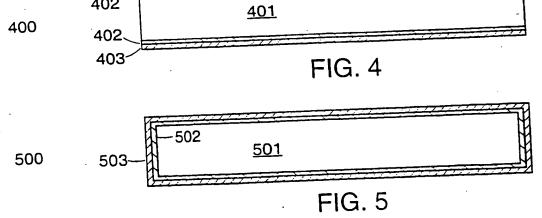
 10 superconducting oxide is a rare earth superconducting copper oxide, a yttrium-barium-copper superconducting oxide or mixtures thereof.
- 23. The process of claim 22 wherein said superconducting oxide is one of the yttrium-barium15 copper-oxide superconducting phases.
 - 24. The process of claim 21 wherein said superconducting oxide coating has a thickness of approximately 1 micrometer to 20 micrometers.
 - 25. The process of claim 21 wherein said buffer 20 layer has a thickness of approximately 0.1 micrometer to 210 micrometers.
 - 26. The process of claim 21 wherein said buffer layer comprises metals, alloys, oxides, or combinations thereof.

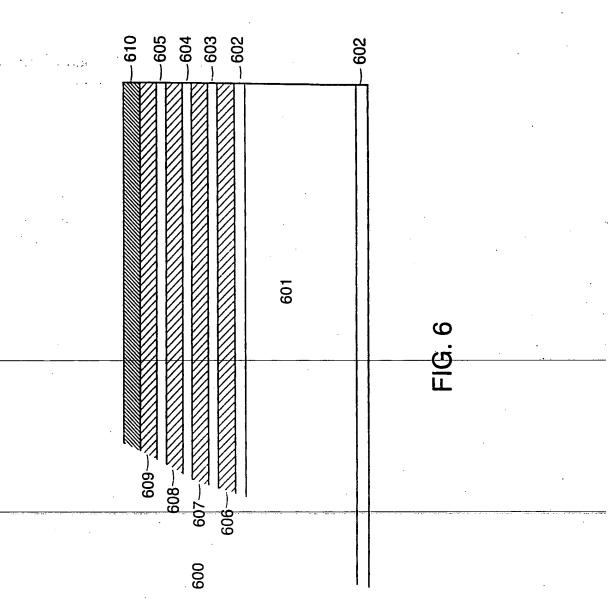
100			
101	SELECT AND	CT AND WEIGH THE CONSTITUENT METALS	
102	MELT THE CO	THE CONSTITUENTS AND COOL	
103	REMELT TO E	REMELT TO ENHANCE HOMOGENEITY	
104	SHAPE THE S FURTHER HO	'E THE SOLIDIFIED MELT AND REDUCE IN SIZE TO HER HOMOGENIZE	zе то
105	MECHANICAL RECRYSTALL	MECHANICALLY DEFORM THE SHAPE TO A SMALLER SIZE AND RECRYSTALLIZE TO FORM A SMALL GRAIN SIZE	LER SIZE AND
106	DEFORMING THE A SMALLER SIZE.	RMING THE SHAPE IN AN AXIALLY SYMMETRIC MANNER TO ALLER SIZE.	AIC MANNER TO
107	PLANAR DEFO OF BETWEEN	IAR DEFORM THE ALLOY TO A REDUCTION IN THICKNESS ETWEEN 85% TO 99.9%	N THICKNESS
108	HEAT TREAT MORE THAN	TREAT AT A TEMPERATURE EXCEEDING 250°C BUT NOT E THAN 95% OF THE MELTING TEMPERATURE	O°C BUT NOT

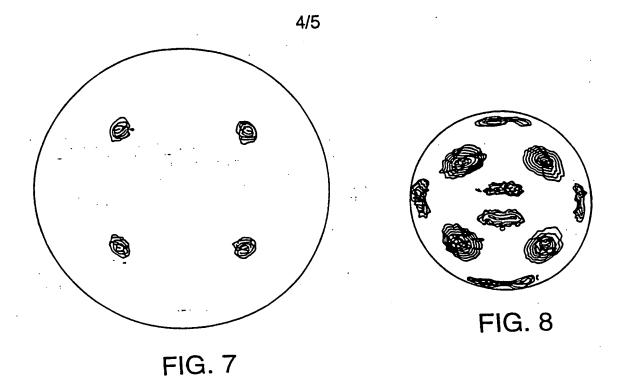
F.G.

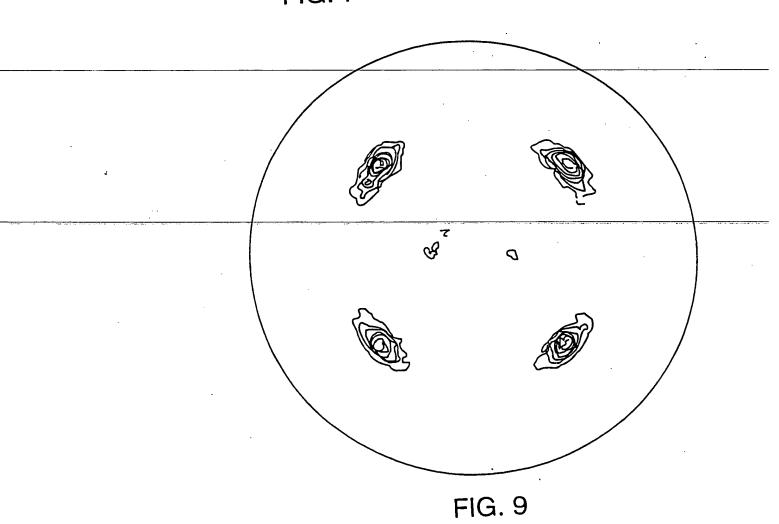
2/5











5/5

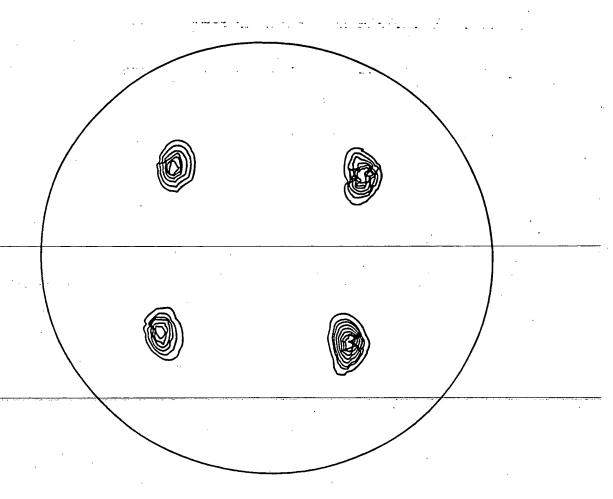


FIG. 10

INTERNATIONAL SEARCH REPORT

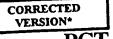
International application No. PCT/US98/20407

IPC(6) :C	FICATION OF SUBJECT MATTER 10B 29/22; C22F 1/00; B05D 15/04, 31/26 10B 29/22; C22F 1/00; C22	classification and IPC	
36	umentation searched (classification system followed by cla	ssification symbols)	
1 115 - 5	05/473, 236, 474, 470, 500; 117/94, 95, 101, 106; 148	1433 , 420/405	
1	n searched other than minimum documentation to the extent	that such documents are included in	the fields scarched
NONE	ta base consulted during the international search (name of	data base and, where practicable,	search terms used)
100 046	ONLINE ns: superconduct, alloy, nickel, copper		
C. DOC	UMENTS CONSIDERED TO BE RELEVANT		_
1	Citation of document, with indication, where appropri	iate, of the relevant passages	Relevant to claim No.
Category*	US 5,439,877 A (FACE) 08 August 1995.		1
A	US 5,006,507 A(WOOLF et al) 09 April	1991.	1
A	US 4,927,788 A(NAKASHIMA et al) 22		1
A Y Y	US 5,516,484 A (KUBOSONO et al) 14 US 4,578,320 A (MAHULIKAR et al) 2 20-40. WO 96/32201 A1(GOYAL et al) 17 Oct	5 March 1986, col. 2 line	
	C Par C	See patent family anner	s.
.b.	Special categories of cited documents: document defining the general state of the art which is not considered	To later document published after the date and not in conflict with the principle or theory underlying document of particular relevant considered novel or cannot be enabled to unvolve an interest considered to unvolve an interest considered to unvolve an interest considered with one or more off being obvious to a person skill document member of the same Date of mailing of the internation	e international filing date or priority application but cited to understand in the invention cannot be insidered to involve an inventive step one ce; the claimed invention cannot be entire step when the document is or such documents, such combination ed in the art is patent family
27 J Name Com	ANUARY 1999 and mailing address of the ISA/US missioner of Patents and Trademarks	Authorized Officer ROBERT KUNEMUND	1999
Box Was	PCT hington, D.C. 20231	7021 200 06	<u> </u>

INTERNATIONAL SEARCH REPORT

International application No. PCT/US98/20407

505/47:	3, 236, 474, 470, 5	500; 117/94, 95	, 101, 106 ; 148/435 ;	420/485		
	•					,
						,
		• .				,
	•	**		•		
			•			
					•	
						•
					•	4
		•				•
•						
	•		· · · · · · · · · · · · · · · · · · ·			
war war and a second						· · · · · · · · · · · · · · · · · · ·
	•					
	•					
	•					
	•					



(30) Priority Data:

WORLD INTELLECTUAL PROPERTY ORGANIZATION International Bureau



8 April 1999 (08.04.99)

INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT) WO 99/16941

US

(11) International Publication Number: (51) International Patent Classification 6: C30B 29/22, C22F 1/00, B05D 15/04, (43) International Publication Date: 31/26

PCT/US98/20407 (21) International Application Number:

30 September 1998 (30.09.98) (22) International Filing Date:

08/942,038 (71) Applicants: AMERICAN SUPERCONDUCTOR CORPORA-TION [US/US]; Two Technology Way, Westborough, MA

1 October 1997 (01.10.97)

01581 (US). THE REGENTS OF THE UNIVERSITY OF CALIFORNIA [US/US]; 21st floor, 300 Lakeside Drive, Oakland, CA 94612-3550 (US).

(72) Inventors: FRITZEMEIER, Leslie, G.; 72 Concord Road, Acton, MA 01720 (US). THOMPSON, Elliott, D.; 157 Rathbun Street, Coventry, RI 02816 (US). SIEGAL, Edward, J.; 28 Magnolia Street, Malden, MA 02148 (US). THIEME, Cornelis, Leo, Hans; 21 Mill Road, Westborough, MA 01581 (US). CAMERON, Robert, D.; 90 Daniels Street, Franklin, MA 02038 (US). SMITH, James, L.; 320 Donna Avenue, Los Alamos, NM 87544 (US). HULTS, W., Larry; 811 Tiffany Court, Los Alamos, NM 87544 (US).

(74) Agent: WALPERT, Gary, A.; Fish & Richardson P.C., 225 Franklin Street, Boston, MA 02110-2804 (US).

(81) Designated States: AU, CA, CN, JP, NZ, RU, European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

Published

With international search report. Before the expiration of the time limit for amending the claims and to be republished in the event of the receipt of amendments.

(54) Title: SUBSTRATES FOR SUPERCONDUCTORS

		ıı
100		
101	SELECT AND WEIGH THE CONSTITUENT METALS	
102	MELT THE CONSTITUENTS AND COOL	
103	REMELT TO ENHANCE HOMOGENEITY	
104	SHAPE THE SOLIDIFIED MELT AND REDUCE IN SIZE TO	
1	-UNINCH HUMOGUMEL	4
105	MECHANICALLY DEFORM THE SHAPE TO A SMALLER SIZE AND RECRYSTALLIZE TO FORM A SMALL GRAIN SIZE	
108	DEFORMING THE SHAPE IN AN AXIALLY SYMMETRIC MANNER TO A SMALLER SIZE.	
107	PLANAR DEFORM THE ALLOY TO A REDUCTION IN THICKNESS OF BETWEEN 85% TO 99.9%	
108	HEAT TREAT AT A TEMPERATURE EXCEEDING 250°C BUT NOT MORE THAN 85% OF THE MELTING TEMPERATURE	

(57) Abstract

An alloy capable of forming a (100) [001] cube-texture by thermo-mechanical techniques has 5-45 atomic percent nickel with t balance being copper. The alloy is useful as a conductive substrate for superconducting composites where the substrate is coated with superconducting oxide. A buffer layer can optionally be coated on the substrate to enhance deposition of the superconducting oxide. T method for producing the alloy can include weighing the metal (101), melting and cooling the constituents (102). The alloy can inclu melted (103) and shaped (104). The alloy can then be mechanically deformed to a smaller size and recrystallize (105) then deformed in axially manner (106) and planar deformation (107). The final step is heat treated (108).

FOR THE PURPOSES OF INFORMATION ONLY

Codes used to identify States party to the PCT on the front pages of pamphlets publishing international applications under the PCT.

AL	Alhania	ES	Spain	LS	Lesotho	SI	Classe *
AM	Armenia	FI	Finland	LT	Lithuania		Slovenia
AT	Austria	FR	France	LU	Luxembourg	SK SN	Slovakia
ΑÜ	Australia	GA	Gabon	LV	Latvia		Senegal
ΑZ	Azerbaijan	ĢВ	United Kingdom	MC	Monaco	SZ	Swaziland
BA	Bosnia and Herzegovina	GE	Georgia	MD	Republic of Moldova	TD	Chad
BB	Barbados	GH	Ghana	MG	Madagascar	TG	Togo
BE	Belgium	GN	Guinea	MK	The former Yugoslav	TJ	Tajikistan
BF	Burkina Faso	GR	Greece	1417		TM	Turkmenistan
BG	Bulgaria	HU	Hungary	ML	Republic of Macedonia Mali	TR	Turkey
BJ	Benin	IE	Ireland	MN		TT	Trinidad and Tobago
BR	Brazil	IL	Israel	MR	Mongolia	UA	Ukraine
BY	Belarus	IS	Iceland	MW	Mauritania	UG	Uganda
CA	Canada	IT	Italy	MX MX	Malawi	US	United States of Americ
CF	Central African Republic	JP	Japan		Mexico	UZ	Uzbekistan
CG	Congo	KE	Kenya	NE	Niger	VN	Viet Nam
CH	Switzerland	KG	Kyrgyzstan	NL	Netherlands	YU	Yugoslavia
CI	Côte d'Ivoire	KP		NO	Norway	zw	Zimbabwe
СМ	Cameroon	K.F	Democratic People's	NZ	New Zealand		
CN	China	KR	Republic of Korea	PL	Poland		
CU	Cuba	KZ	Republic of Korea	PT	Portugal		
CZ	Czech Republic	LC	Kazakstan	RO	Romania		
DE	Germany	u	Saint Lucia	RU	Russian Federation		
DK	Denmark		Liechtenstein	SD	Sudan		
EE	Estonia	LK	Sri Lanka	SE	Sweden-		
	CHOMB	LR	Liberia	SG	Singapore		